	Subclass	ISSUE CLASSIFICATION
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PATENT NUMBER

U.S. **UTILITY** Patent Application

PATENT DATE

APPLICATION NO. CONT/PRIOR CLASS ART UNIT EXAMINÈR 09/883210 257

Hiroyuki Nitta Yoshiaki Fukuzumi Yusuke Kohyama

Semiconductor device having a wirland method for manufacturing the same ayer of damascene structure

**APPLICANTS** 

**ISSUING CLASSIFICATION ORIGINAL** CROSS REFERENCE(S) **CLASS** SUBCLASS **CLASS** SUBCLASS (ONE SUBCLASS PER BLOCK) INTERNATIONAL CLASSIFICATION Continued on Issue Slip Inside File Jacket

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TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
The term of this patent subsequent to (date)				NOTICE OF ALLOWANCE MAILED	
has been disclaimed.	(Assistant i	xaminer)	(Date)	•	
The term of this patent shall not extend beyond the expiration date			(30.0)	and the second	
of U.S Patent. No			ISSUE FEE		
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The information disclosed herein may be restri Possession outside the U.S. Patent & Tredema	icted. Unauthorized di	sclosure may be pro	ohibited by the Un	ited States Code Title 35.	Sections 122 181 and 250

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